



GaAs MMIC DOUBLE-BALANCED HIGH IP3 MIXER, 9 - 15 GHz

Typical Applications

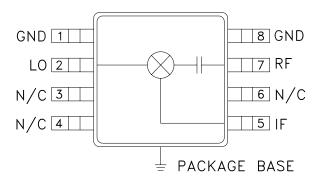
The HMC410AMS8G(E) is ideal for:

- Long Haul Radio Platforms
- Microwave Radio
- VSAT

Features

Conversion Loss: 8 dB LO/RF Isolation: 40 dB LO/IF Isolation: 37 dB Input IP3: +24 dBm No External Components MSOP8G SMT Package

Functional Diagram



General Description

The HMC410AMS8G(E) is a passive double-balanced high IP3 mixer that operates between 9 and 15 GHz. The HMC410AMS8G(E) operates with LO drive levels between +13 dBm and +19 dBm, and provides 8 dB conversion loss across the entire specified frequency band. These mixers require no external components or bias.

Electrical Specifications, $T_A = +25^{\circ}$ C

Parameter	IF = 1.45 GHz LO = +17 dBm			Units
	Min.	Тур.	Max.	
Frequency Range, RF & LO	9 - 15		GHz	
Frequency Range, IF	DC - 2.5		GHz	
Conversion Loss		8	11	dB
Noise Figure (SSB)		8	11	dB
LO to RF Isolation	30	40 - 45		dB
LO to IF Isolation	30	37		dB
RF to IF Isolation	8	17		dB
IP3 (Input)	20	24		dBm
1 dB Compression (Input)	11	14		dBm

* Unless otherwise noted, all measurements performed as downconverter, IF= 1.45 GHz.

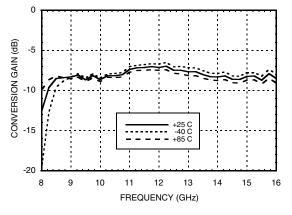
For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com Application Support: Phone: 978-250-3343 or apps@hittite.com



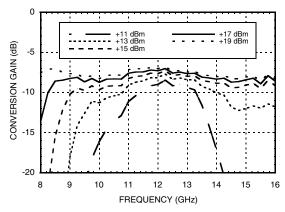


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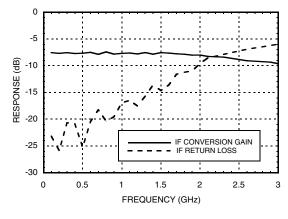
Conversion Gain vs. Temperature @ LO = +17 dBm



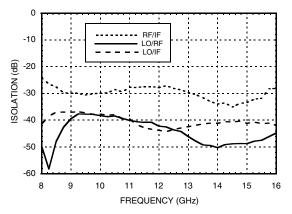
Conversion Gain vs. LO Drive



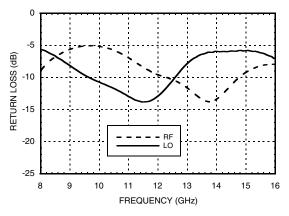
IF Bandwidth @ LO = +17 dBm



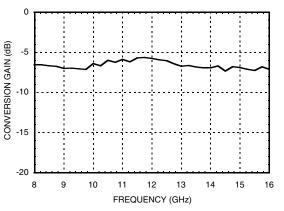
Isolation @ LO = +17 dBm



Return Loss @ LO = +17 dBm



Upconverter Performance Conversion Gain @ LO = +17 dBm



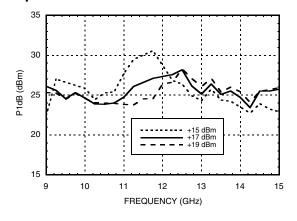
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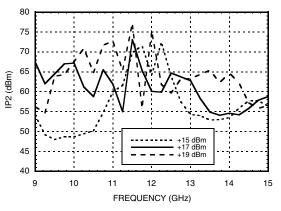


RoHS

Input IP3 vs. LO Drive*



Input IP2 vs. LO Drive *



MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	ХХ	4	28	23	N/A
1	15	0	40	62	46
2	85	70	67	78	83
3	>90	>90	>90	79	>90
4	N/A	>90	>90	>90	>90
$\label{eq:RF} \begin{array}{l} RF = 14.45 \; GHz @ \ \text{-10} \; dBm \\ LO = 13 \; GHz @ \ \text{+17} \; dBm \\ All \; values \; in \; dBc \; relative \; to \; the \; IF \; power \; level. \\ Measured \; as \; downconverter. \end{array}$					

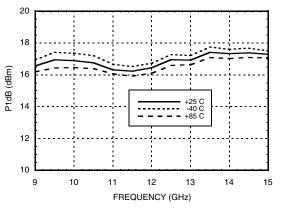
HMC410AMS8G / 410AMS8GE

Input IP3 vs.

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Temperature @ LO = +17 dBm* 35 30 P1dB (dBm) 25 +25 C 20 -40 C +85 C 15 10 14 15 9 11 12 13 FREQUENCY (GHz)

Input P1dB vs. Temperature @ LO = +17 dBm



Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
9	34	28	46	60
10.5	37	37	50	69
12	44	45	46	60
13.5	47	46	62	N/A
15	40	56	58	N/A
16.5 34 47 51 N/A				
LO = +17 dBm All values in dBc below input LO level @ RF port.				

* Two-tone input power = 0 dBm each tone, 1 MHz spacing.

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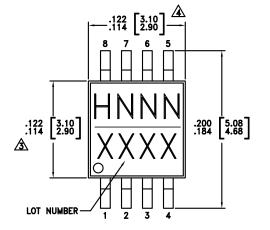
Absolute Maximum Ratings

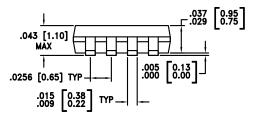
RF / IF Input	+20 dBm	
LO Drive	+27 dBm	
IF DC Current	±4 mA	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing







.009 0.22

.031 0.80 .016 0.40

> .070 [1.78] MAX

1. LEADFRAME MATERIAL: COPPER ALLOY

2. DIMENSIONS ARE IN INCHES [MILLIMETERS]

3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO

.095 [2.41 MAX

PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC410AMS8G	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H410A XXXX
HMC410AMS8GE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H410A XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

EXPOSED GROUND PADDLE MUST BE CONNECTED TO

RF/DC GROUND.

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RoHS V

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Pin Descriptions

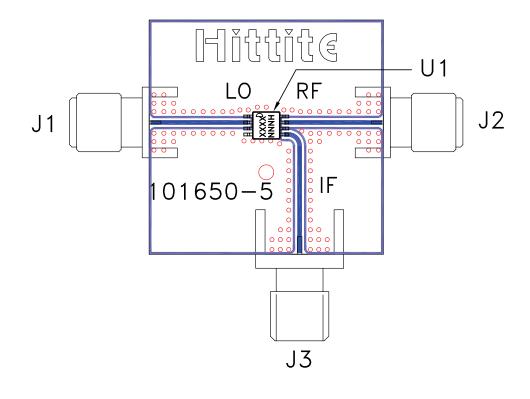
Pin Number	Function	Description	Interface Schematic
1, 8	GND	Pins and exposed ground slug must be connected to RF ground.	
2	LO	This pin is AC coupled and matched to 50 Ohms.	
3, 4, 6	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
5	IF	This pin is DC coupled. For applications not requiring opera- tion to DC this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 4mA of current or die non- function and possible die failure will result.	
7	RF	This pin is DC coupled and matched to 50 Ohms.	RFO



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Evaluation PCB



List of Materials for Evaluation PCB 103350 [1]

Item	Description	
J1 - J2	PCB Mount SMA RF Connector, SRI	
J3	PCB Mount SMA Connector, Johnson	
U1	HMC410AMS8G(E) Mixer	
PCB [2]	101650 Evaluation Board	

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.